

TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

ETAS ID: TM709009

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	SECURITY INTEREST		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
HOCKEYTECH INC.		02/17/2022	Corporation: DELAWARE
RECEIVING PARTY DATA			
Name:	Silicon Valley Bank		
Street Address:	504 Lavaca Street, Suite 1100		
City:	Austin		
State/Country:	TEXAS		
Postal Code:	78701		
Entity Type:	Corporation: CALIFORNIA		
PROPERTY NUMBERS Total: 3			
Property Type	Number	Word Mark	
Registration Number:	5280144	HOCKEYTECH	
Registration Number:	6564878	LEAGUESTAT	
Registration Number:	5280143	FASTHOCKEY	
CORRESPONDENCE DATA			
Fax Number:			
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>			
Phone:	8004945225		
Email:	ipteam@cogencyglobal.com		
Correspondent Name:	JAY DASILVA		
Address Line 1:	1025 CONNECTICUT AVE., NW, STE. 712		
Address Line 2:	COGENCY GLOBAL INC.		
Address Line 4:	WASHINGTON, D.C. 20036		
ATTORNEY DOCKET NUMBER:	1600372 TM B		
NAME OF SUBMITTER:	Carolina Becerra		
SIGNATURE:	/Carolina Becerra/		
DATE SIGNED:	02/17/2022		
Total Attachments: 9			
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INTELLECTUAL PROPERTY SECURITY AGREEMENT

This Intellectual Property Security Agreement (this "Agreement") is entered into as of February 17, 2022 by and between **SILICON VALLEY BANK**, a California corporation, with a loan production office located at 504 Lavaca Street, Suite 1100, Austin, Texas 78701 ("Bank") and **HOCKEYTECH INC.**, a Delaware corporation, with its principal place of business located at 3785 NW 65th Lane, Boca Raton, Florida 33496 ("Grantor").

RECITALS

A. Bank has agreed to make certain advances of money and to extend certain financial accommodations to Grantor, **FLOSPORTS, INC.**, a Delaware corporation, **DIRTONDIRT.COM, LLC**, an Illinois limited liability company, **HOCKEYTECH USA LLC**, a Delaware limited liability company, and **HOCKEYTECH CANADA ULC**, an unlimited liability company organized under the laws of the Province of British Columbia (jointly and severally, individually and collectively "Borrower") (the "Loans") in the amounts and manner set forth in that certain Mezzanine Loan and Security Agreement by and among Bank and Borrower dated as of December 11, 2019, as amended by a certain First Loan Modification Agreement dated as of July 28, 2021, as further amended by a certain Consent and Second Loan Modification Agreement dated as of October 1, 2021, and as further amended and affected by a certain Joinder and Third Loan Modification Agreement dated as of the date hereof (as the same has been and as may be further amended, modified or supplemented from time to time, the "Loan Agreement"; capitalized terms used herein are used as defined in the Loan Agreement). Bank is willing to make the Loans to Borrower, but only upon the condition, among others, that Grantor shall grant to Bank a security interest in its Copyrights, Trademarks, Patents, and Mask Works (as each term is described below) to secure the obligations of Borrower to Bank.

B. Pursuant to the terms of the Loan Agreement, Grantor has granted to Bank a security interest in all of Grantor's right, title and interest, whether presently existing or hereafter acquired, in, to and under all of the Collateral.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, and intending to be legally bound, as collateral security for the prompt and complete payment when due of Borrower's obligations to Bank, Grantor hereby represents, warrants, covenants and agrees as follows:

AGREEMENT

1. Grant of Security Interest. To secure Borrower's obligations to Bank, Grantor grants and pledges to Bank a security interest in all of Grantor's right, title and interest in, to and under its intellectual property (all of which shall collectively be called the "Intellectual Property Collateral"), including, without limitation, the following:

(a) Any and all copyright rights, copyright applications, copyright registrations and like protections in each work of authorship and derivative work thereof, whether published or unpublished and whether or not the same also constitutes a trade secret, now or hereafter existing, created, acquired or held, including without limitation those set forth on Exhibit A attached hereto (collectively, the "Copyrights");

(b) Any and all trade secrets, and any and all intellectual property rights in computer software and computer software products now or hereafter existing, created, acquired or held;

(c) Any and all design rights that may be available to Grantor now or hereafter existing, created, acquired or held;

(d) All patents, patent applications and like protections including, without limitation, improvements, divisions, continuations, renewals, reissues, extensions and continuations-in-part of the same, including without limitation the patents and patent applications set forth on Exhibit B attached hereto (collectively, the "Patents");

(e) Any trademark and servicemark rights, whether registered or not, applications to register and registrations of the same and like protections, and the entire goodwill of the business of Grantor connected with and symbolized by such trademarks, including without limitation those set forth on Exhibit C attached hereto (collectively, the "Trademarks");

(f) All mask works or similar rights available for the protection of semiconductor chips, now owned or hereafter acquired, including, without limitation those set forth on Exhibit D attached hereto (collectively, the "Mask Works");

(g) Any and all claims for damages by way of past, present and future infringements of any of the rights included above, with the right, but not the obligation, to sue for and collect such damages for said use or infringement of the intellectual property rights identified above;

(h) All licenses or other rights to use any of the Copyrights, Patents, Trademarks, or Mask Works and all license fees and royalties arising from such use to the extent permitted by such license or rights;

(i) All amendments, extensions, renewals and extensions of any of the Copyrights, Trademarks, Patents, or Mask Works; and

(j) All proceeds and products of the foregoing, including without limitation all payments under insurance or any indemnity or warranty payable in respect of any of the foregoing.

2. Recordation. Grantor authorizes the Commissioner for Patents, the Commissioner for Trademarks and the Register of Copyrights and any other government officials to record and register this Agreement upon request by Bank.

3. Authorization. Grantor hereby authorizes Bank to (a) modify this Agreement unilaterally by amending the exhibits to this Agreement to include any Intellectual Property Collateral which Grantor obtains subsequent to the date of this Agreement, and (b) file a duplicate original of this Agreement containing amended exhibits reflecting such new Intellectual Property Collateral.

4. Loan Documents. This Agreement has been entered into pursuant to and in conjunction with the Loan Agreement, which is hereby incorporated by reference. The provisions of the Loan Agreement shall supersede and control over any conflicting or inconsistent provision herein. The rights and remedies of Bank with respect to the Intellectual Property Collateral are as provided by the Loan Agreement and related documents, and nothing in this Agreement shall be deemed to limit such rights and remedies.

5. Execution in Counterparts. This Agreement may be executed in counterparts (and by different parties hereto in different counterparts), each of which shall constitute an original, but all of which when taken together shall constitute a single contract. Delivery of an executed counterpart of a signature page to this Agreement by facsimile or in electronic (i.e., "pdf" or "tif" format) shall be effective as delivery of a manually executed counterpart of this Agreement.

6. Successors and Assigns. This Agreement will be binding on and shall inure to the benefit of the parties hereto and their respective successors and assigns.

7. Governing Law. This Agreement and any claim, controversy, dispute or cause of action (whether in contract or tort or otherwise) based upon, arising out of or relating to this Agreement and the transactions contemplated hereby and thereby shall be governed by, and construed in accordance with, the laws of the United States and the State of California, without giving effect to any choice or conflict of law provision or rule (whether of the State of California or any other jurisdiction).

[Signature page follows.]

IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

GRANTOR:

HOCKEYTECH INC.

DocuSigned by:
By: Mark Floreani
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Title: President

BANK:

SILICON VALLEY BANK

DocuSigned by:
By: Kyle Larrabee
8FF9AB30C4BC4EE...

Title: Director

EXHIBIT A

Copyrights

Description

Registration/
Application
Number

Registration/
Application
Date

None.

EXHIBIT B

Patents

Description

Registration/
Application
Number

Registration/
Application
Date

None.

EXHIBIT C

Trademarks

(see attached)

STATUS REPORT – HockeyTech Inc.

I. United States – Federal Trademark Applications/Registration

MARK	FILE NO.	FILING DATE	APPLICATION NO.	REG. DATE	REG. NO.	STATUS
HockeyTech	825504-2	01/13/2017	87/301,629	09/05/2017	5,280,144	Registered
						Section 8 & 15 (Declaration of Use) due: 09/05/22-2023
LeagueStat	825504-5	01/13/2017	87/301,668	11/23/2021	6,564,878	Registered
FASTHOCKEY	825504-7	01/13/2017	87/301,626	09/05/2017	5,280,143	Registered
						Section 8 & 15 (Declaration of Use) due: 09/05/22-2023

II. Foreign Trademark Applications/Registration

MARK	FILE NO.	COUNTRY	FILING DATE	APPLICATION NO.	ISSUE DATE	REG. NO.	STATUS
HOCKEYTECH	825504-8	Canada	07/13/2017	1847347	11/30/2020	1088750	Registered
FASTHOCKEY	825504-11	Canada	07/13/2017	1847346	04/02/2020	1076296	Registered
HockeyTech	825504-13	European Union	07/13/2017	016985211	11/09/2017	016985211	Registered
LeagueStat	825504-16	European Union	07/13/2017	016982365	11/09/2017	016982365	Registered
FASTHOCKEY (Word Mark)	825504-17	European Union	07/13/2017	016982357	11/09/2017	016982357	Registered

EXHIBIT D

Mask Works

Description

Registration/
Application
Number

Registration/
Application
Date

None.